



Dear customer

ROHM Co., Ltd. ("ROHM"), on the 1st day of April, 2024,  
has absorbed into merger with 100%-owned subsidiary of LAPIS Technology Co., Ltd.

Therefore, all references to "LAPIS Technology Co., Ltd.", "LAPIS Technology"  
and/or "LAPIS" in this document shall be replaced with "ROHM Co., Ltd."

Furthermore, there are no changes to the documents relating to our products other than  
the company name, the company trademark, logo, etc.

Thank you for your understanding.

ROHM Co., Ltd.  
April 1, 2024

Dear customer

LAPIS Semiconductor Co., Ltd. ("LAPIS Semiconductor"), on the 1<sup>st</sup> day of October, 2020, implemented the incorporation-type company split (shinsetsu-bunkatsu) in which LAPIS established a new company, LAPIS Technology Co., Ltd. ("LAPIS Technology") and LAPIS Technology succeeded LAPIS Semiconductor's LSI business.

Therefore, all references to "LAPIS Semiconductor Co., Ltd.", "LAPIS Semiconductor" and/or "LAPIS" in this document shall be replaced with "LAPIS Technology Co., Ltd."

Furthermore, there are no changes to the documents relating to our products other than the company name, the company trademark, logo, etc.

Thank you for your understanding.

LAPIS Technology Co., Ltd.  
October 1, 2020

# ML7386/ML7386B LSI Evaluation Kit Start Guide

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Please read at the beginning

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## Introduction

Before using the product, please read this Start Guide.

Always ensure that the product is used correctly.

Keep the guide handy for future reference.

This guide describes package contents and connection with PC.

Documents listed below in addition to this document, please read together as necessary.

- ML7386/ML7386B Data sheet
- ML7386/ML7386B Design guide
- ML7386/ML7386B Application manual
- ML7386/ML7386B Characteristic data

All other company and products names are the trademarks or registered trademarks of the respective companies.

## Notation

Classification	Notation	Description
• Numeric value	<i>0xnn</i>	Represents a hexadecimal number.
	<i>0bnnnn</i>	Represents a binary number.
• Address	<i>0xnnnn_nnnn</i>	Represents a hexadecimal number. (indicates 0xnnnnnnnn)
• Unit	word, W	1 word = 32 bits
	byte, B	1 byte = 8 bits
	Mega, M	$10^6$
	Kilo, K (uppercase)	$2^{10}=1024$
	Kilo, k (lowercase)	$10^3=1000$
	Milli, m	$10^{-3}$
	Micro, $\mu$	$10^{-6}$
Nano, n	$10^{-9}$	
• Terminology	“H” level	Signal level on the high voltage side; indicates the voltage level of $V_{IH}$ and $V_{OH}$ as defined in electrical characteristics.
	“L” level	Signal level on the low voltage side; indicates the voltage level of $V_{IL}$ and $V_{OL}$ as defined in electrical characteristics.
• Register description		Read/write attribute: R indicates read-enabled; W indicates write-enabled. MSB: Most significant bit in an 8-bit register (memory) LSB: Least significant bit in an 8-bit register (memory)

## Contents

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## 1. Handling Precautions of this product

- This product is evaluation kit. Available only for evaluation purposes.
- For the application software of this product, please use a PC which Japanese version Windows XP / Windows 7 is installed on.
- Distributing and copying of the software provided with this product are all expressly prohibited.
- For use illegal and remodeling of this product, we cannot take any responsibility.
- In the unlikely event that harmful radio interference is generated from this product, stop the output of the radio or change the frequency used immediately, please perform the treatment, such as for interference avoidance.



## 2. Setup Flow

### STEP 1

Confirming the Package Contents

### STEP 2

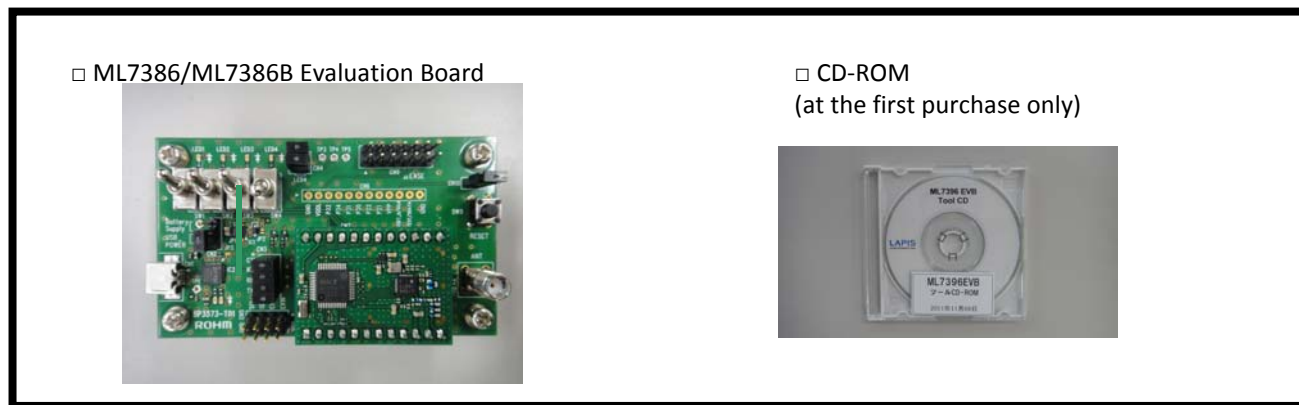
Setting up Serial Communication Software

### STEP1 Confirming the Package Contents

The following items are included in the package. If something is missing or broken, please contact the supplier at which you purchase the product.

\* Package Contents might be changed from following photos.

Please prepare regulated power supply, USB mini-B cable (straight), serial communication software (TeraTerm) yourself.



### STEP2 Setting up Serial Communication Software

\* We recommend Tera Term (free software) as a serial communication software. Macro to be used in simple MAC, has been written in the macro language of an Tera Term.  
Before you start this operation, please download from the internet.

1. Please install Tera Term to your computer.
2. Please connect the evaluation board to the computer with USB mini-B cable(straight).
3. Please start Tera Term.

Fig 1 will be displayed on the screen.

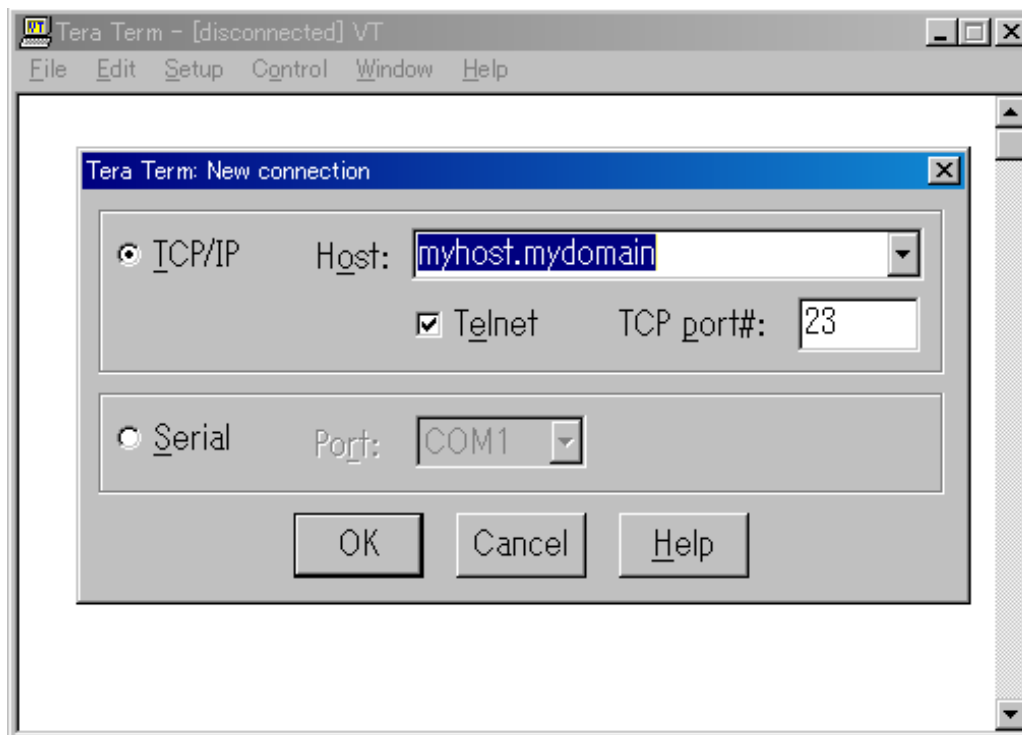


Fig1. Tera Term Startup Screen

4. Please click radio button in front of "Serial", then select COM Port to be used.
5. Please click "Serial port" in the "Setup", then change the setting as fig 2.  
Baud Rate: 38400  
Data: 8 bit  
Parity: none  
Stop: 1 bit  
Flow Control: hardware
6. Please click "Terminal...." in the "Setup", then change the setting as fig 2.  
In the New Line  
Receive : CR+LF  
Transmit: CR  
  
Local echo: checked

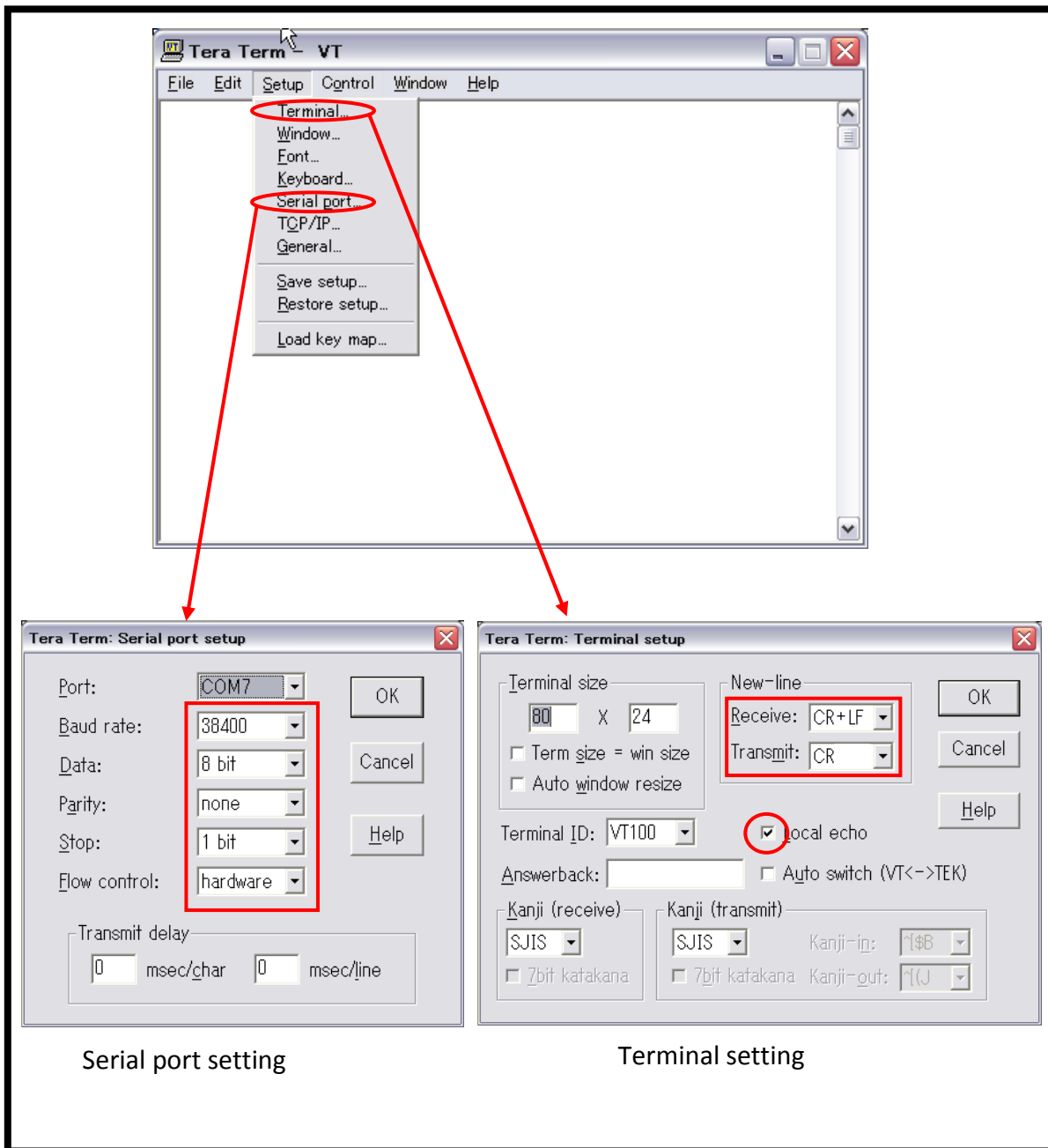


Fig2. Tera Term Communication setting

Please turn on the evaluation board.

7. Please type “RREG 6C” return. If “OK 88” is displayed, your setting is O.K.

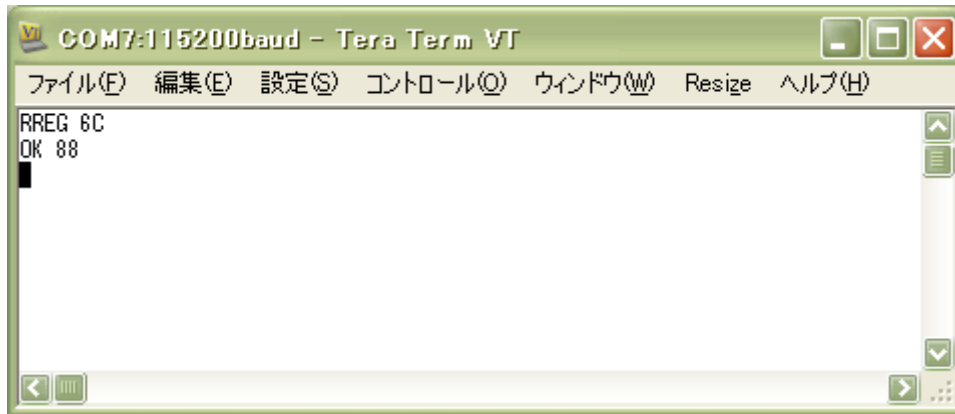


Fig3. Screen after typing “RREG 6C” return

Preparation of this product is complete.

After this setup, please make sure that they are working properly by carrying out a simple communication test. Please refer Simple MAC User's Manual for the communication test.

